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INFORMATION DISCLOSURE CITATION IN AN APPLICATION		APPLICANT Meral Bradley Woodberry	
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U.S. PTO
09/1528955
03/16/00

U S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	DATE IF APPROP.
	5,047,711	09/10/91	Smith et al.	324	158R	08/23/89
	4,968,931	11/06/90	Littlebury et al.	324	158R	11/03/89

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY/NAME	CLASS	SUB CLASS	TRANSLATION YES NO

OTHER DOCUMENTS

	Article entitled, "Securing Known Good Die", by T. A. Williams, published in Advanced Packaging, Fall 1992, pp. 50-59
	Article entitled, Known-Good Die Poised to Take Off', by D. Maliniak, published in Electronic Design, 11-21-94, pp. 55-73
	Article entitled, "Burn-In Co-Developed by TI, MicroModule System, Intel Launches 'SmartDie' Program, by Jim Detar, published in Electronic News, May 30, 1994
	Article entitled, "Known Good Die: A Commercial Solution for Bum-in and Test Before Packaging" by S-H Foo and L. Prokopchak, presented at Semicon Japan, 12-94
	Article entitled, "Flexibility and Modularity Drive Today's Burn-In/Test Systems" by P. Mayerfeld, reprinted from EE-Evaluation Engineering, November 1994
	Specification entitled, "Known Good Die – The Total Solution", AEHR Test Systems/Nitto-Denko

EXAMINER	DATE CONSIDERED